

MOSFET - Power, Dual, N-Channel

60 V, 28 mΩ, 26 A

NTMFD5C680NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low $R_{DS(on)}$ to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V_{DSS}	60	V
Gate-to-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current $R_{\theta JC}$ (Notes 1, 2, 3)	$T_C = 25^\circ\text{C}$	I_D	20	A
			15	
	$T_C = 100^\circ\text{C}$	P_D	24	W
			12	
Power Dissipation $R_{\theta JC}$ (Notes 1, 2)	$T_C = 25^\circ\text{C}$	I_D	7.4	A
			5.5	
	$T_C = 100^\circ\text{C}$	P_D	3.2	W
			1.6	
Pulsed Drain Current	$T_A = 25^\circ\text{C}$, $t_p = 10\ \mu\text{s}$	I_{DM}	66	A
Operating Junction and Storage Temperature		T_J, T_{stg}	-55 to +175	°C
Source Current (Body Diode)		I_S	20	A
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 5\text{ A}$)		E_{AS}	47	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		T_L	260	°C

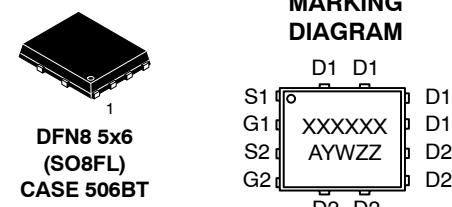
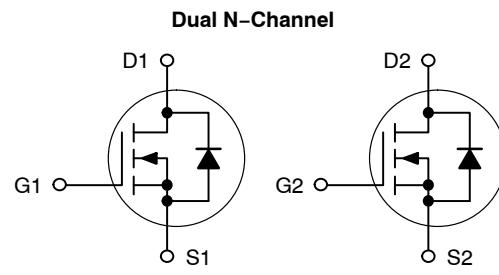
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	6.27	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	46.6	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

$V_{(BR)DSS}$	$R_{DS(\text{ON}) \text{ MAX}}$	$I_D \text{ MAX}$
60 V	28 mΩ @ 10 V	26 A
	41 mΩ @ 4.5 V	



A = Assembly Location
 Y = Year
 W = Work Week
 ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NTMFD5C680NL

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				29		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25 °C			10	μA
			T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA

ON CHARACTERISTICS (Note 4)

Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 13 μA		1.2		2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)/T_J}				-4.3		mV/°C
Drain-to-Source On Resistance	R _{DSS(on)}	V _{GS} = 10 V	I _D = 5 A		23	28	mΩ
		V _{GS} = 4.5 V	I _D = 5 A		33	41	
Forward Transconductance	g _{FS}	V _{DS} = 15 V, I _D = 10 A			50		S

CHARGES, CAPACITANCES & GATE RESISTANCE

Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V		350		pF
Output Capacitance	C _{OSS}			150		
Reverse Transfer Capacitance	C _{rss}			6		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 10 A	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 10 A	2.0		nC
Total Gate Charge	Q _{G(TOT)}		V _{GS} = 10 V, V _{DS} = 48 V; I _D = 10 A	5.0		
Threshold Gate Charge	Q _{G(TH)}			0.8		
Gate-to-Source Charge	Q _{GS}			1.2		
Gate-to-Drain Charge	Q _{GD}			0.8		
Plateau Voltage	V _{GP}			3.0		V

SWITCHING CHARACTERISTICS (Note 5)

Turn-On Delay Time	t _{d(ON)}	V _{GS} = 4.5 V, V _{DS} = 48 V, I _D = 5 A, R _G = 1.0 Ω		6.4		ns
Rise Time	t _r			25		
Turn-Off Delay Time	t _{d(OFF)}			19		
Fall Time	t _f			23		

DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 5 A	T _J = 25°C		0.9	1.2	V
			T _J = 125°C		0.8		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 10 A/μs, I _S = 5 A			17		ns
Charge Time	t _a				8		
Discharge Time	t _b				9		
Reverse Recovery Charge	Q _{RR}				7		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

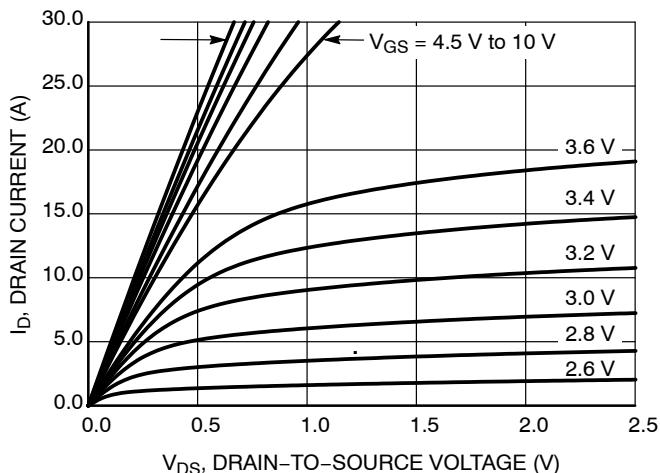


Figure 1. On-Region Characteristics

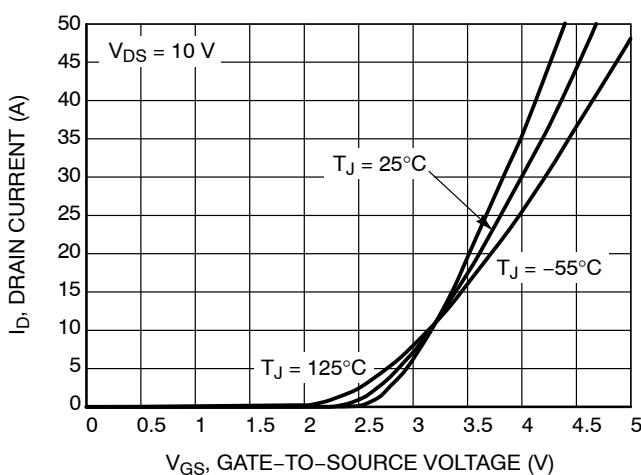


Figure 2. Transfer Characteristics

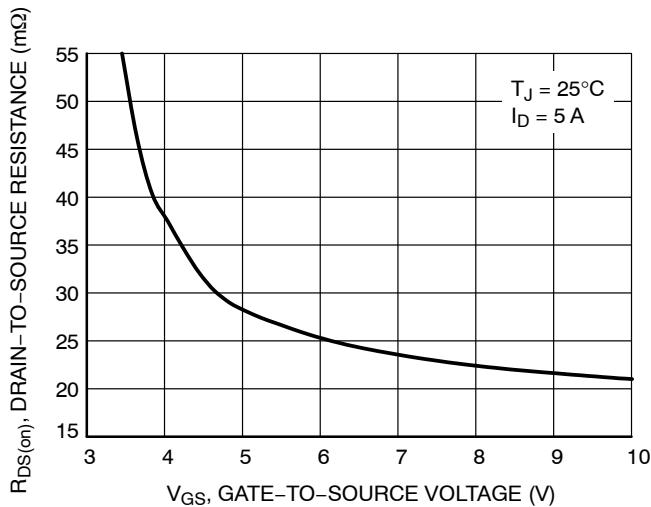


Figure 3. On-Resistance vs. Gate-to-Source Voltage

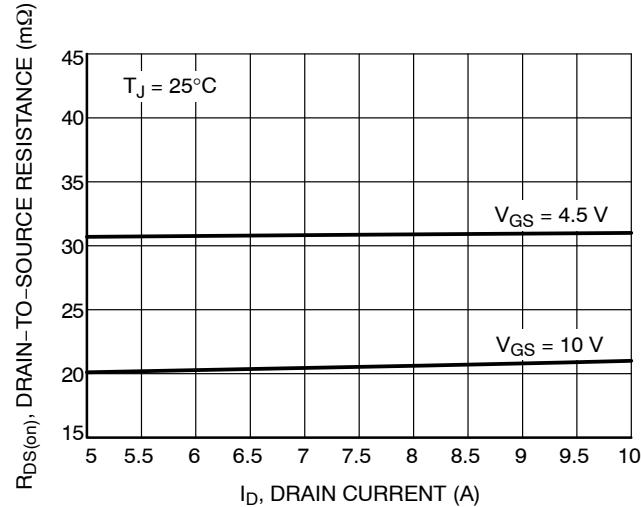


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

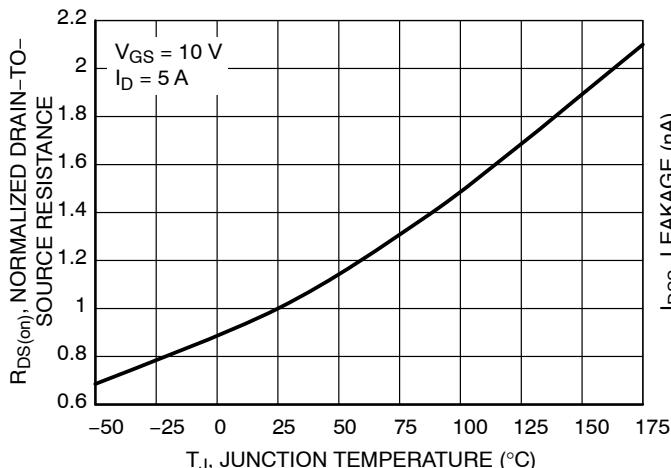


Figure 5. On-Resistance Variation with Temperature

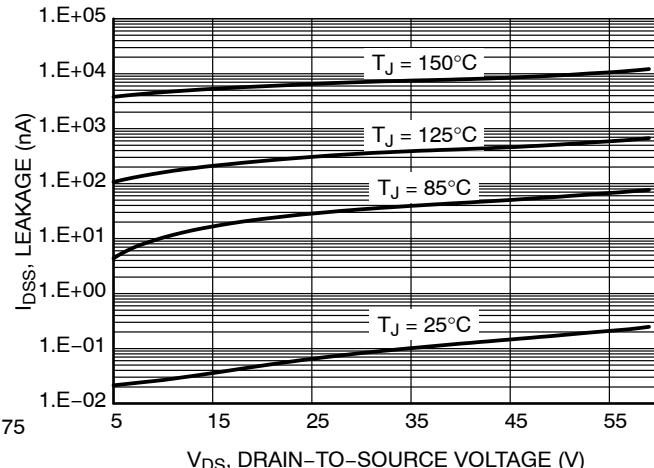
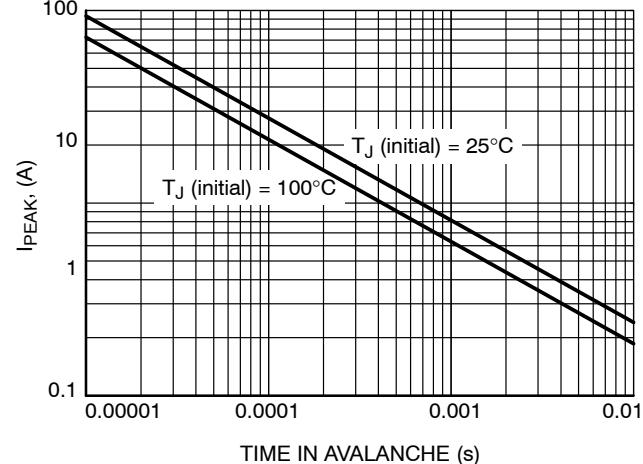
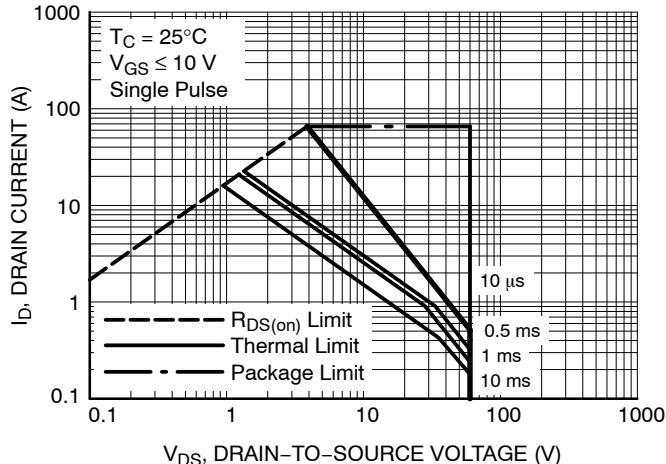
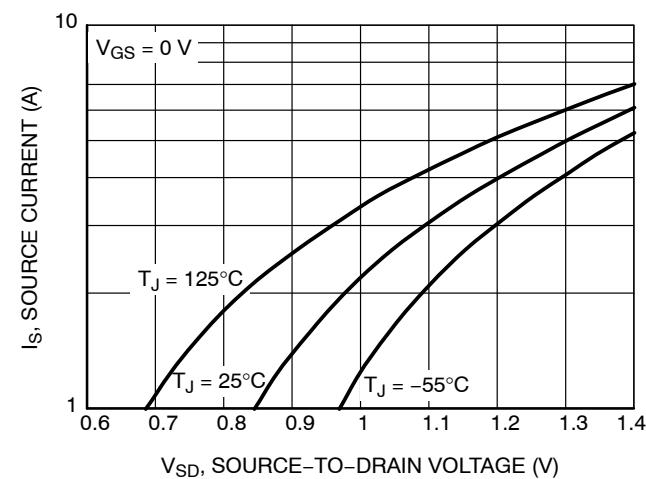
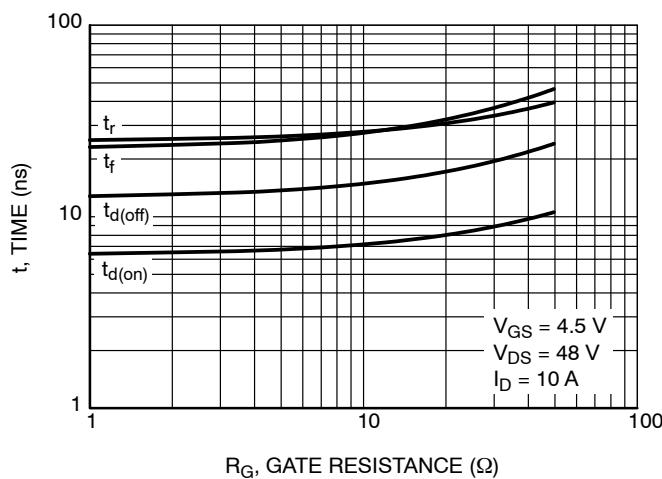
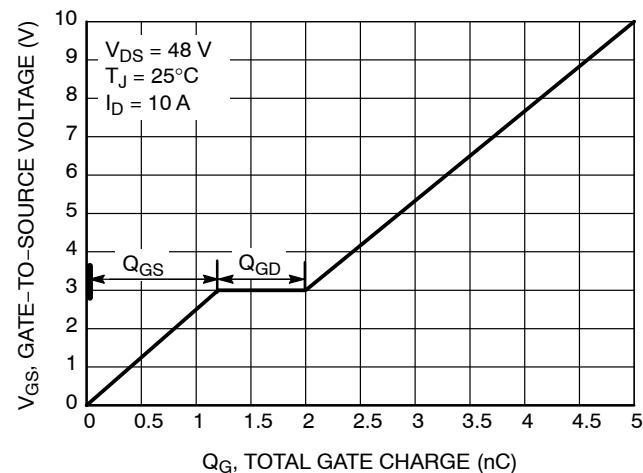
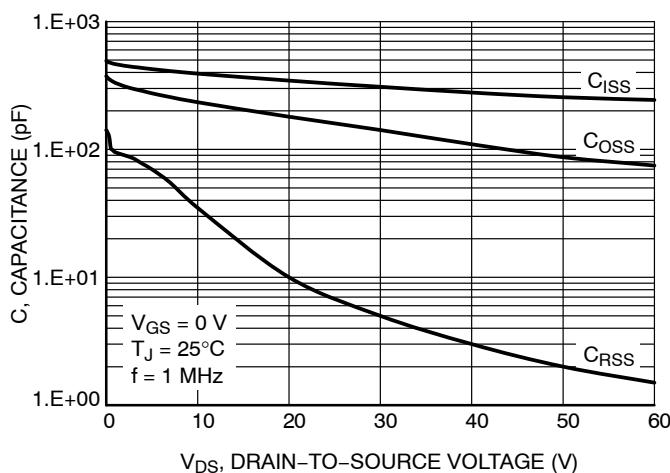


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



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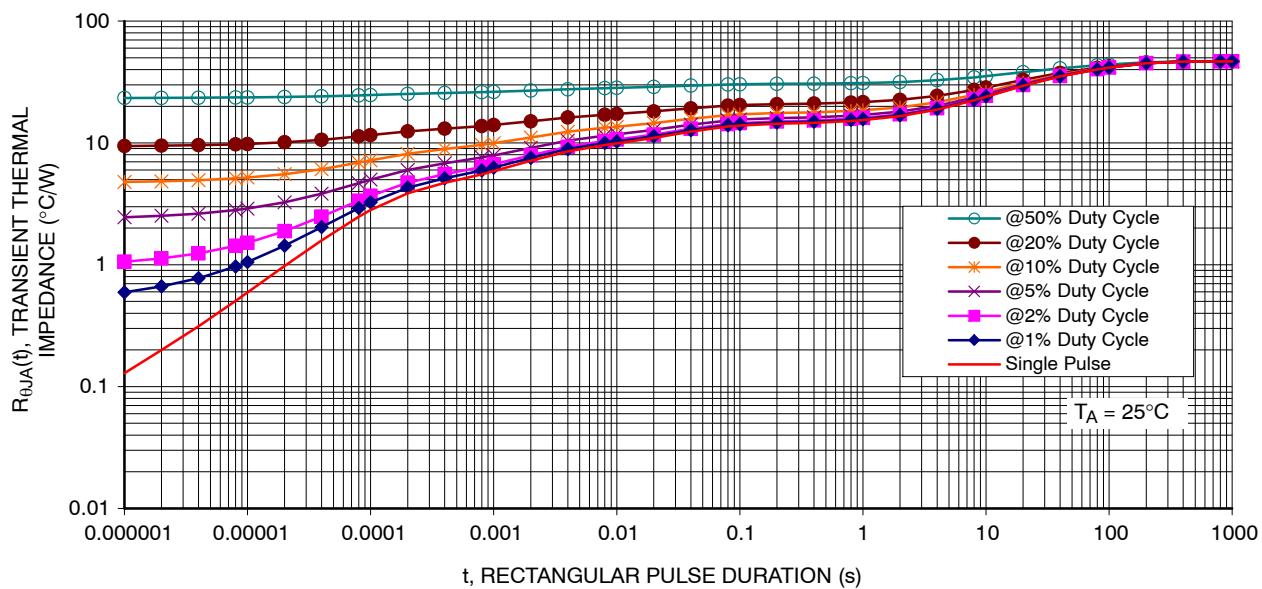


Figure 13. Thermal Response

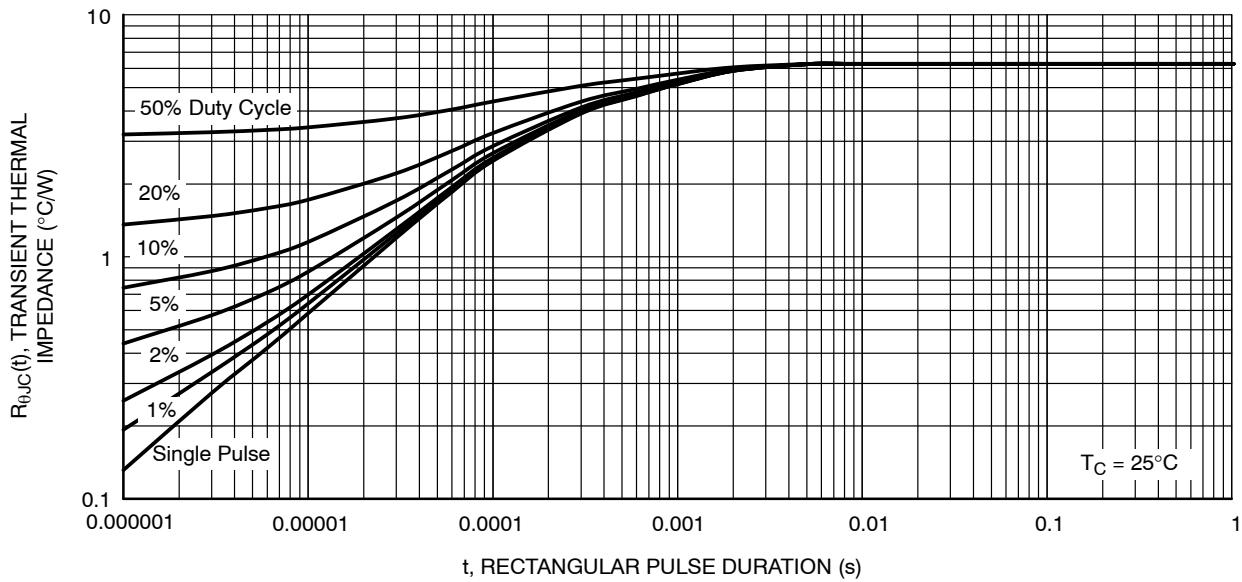


Figure 14. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFD5C680NLT1G	5C680L	DFN8 (Pb-Free)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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